

## 9.0-9.6 GHz Low Noise Amplifier

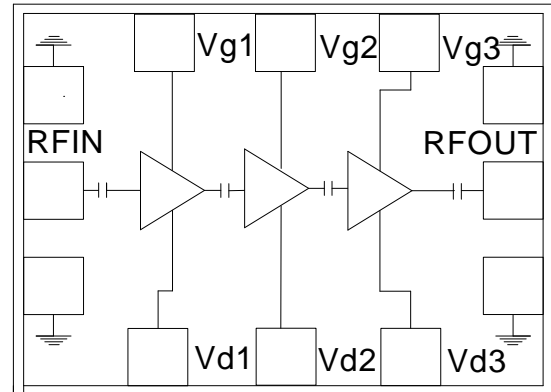
### Features

- ◆ Frequency Range : 9-9.6 GHz
- ◆ Low Noise Figure < 1.3 dB
- ◆ 26.5 dB nominal gain
- ◆ 10 dBm P<sub>1dB</sub>
- ◆ High IP3
- ◆ Input Return Loss > 12 dB
- ◆ Output Return Loss > 10 dB
- ◆ DC decoupled input and output
- ◆ 0.15 μm InGaAs pHEMT Technology
- ◆ Chip dimension: 3.0 x 3.0 x 0.1 mm

### Typical Applications

- ◆ RADAR
- ◆ Military
- ◆ Test Equipment and sensors
- ◆ Point-to-Point Radios, Point-to-Multi-Point Radios & VSATS

### Functional Diagram



### Description

The ASTRA 2142024 is a three stage ultra low noise amplifier that operates from 9.0-9.6 GHz. The LNA features 26.5 dB gain and has a typical mid-band noise figure of 1.3 dB. The LNA has nominal input return losses of 12 dB and output return loss of 10 dB. The nominal P1dB is 10 dBm.

Dual bias technique has been employed to facilitate gain control with gate bias. Circuit ground is provided through vias to backside metallization. The ASTRA 2142024 performs well as a low noise amplifier in receive applications and as a driver or buffer amplifier where high gain, excellent linearity and low power consumption are important.

### Absolute Maximum Ratings<sup>1</sup>

Parameter	Absolute Maximum	Units
Drain bias voltage (Vd)	+6	volts
RF input power	+10	dBm
Operating temperature	-50 to +85	°C
Storage Temperature	-65 to +150	°C

1. Operation beyond these limits may cause permanent damage to the component

**Electrical Specifications @  $T_A = 25^\circ\text{C}$ ,  $V_{d1} = V_{d2} = V_{d3} = 5\text{V}$ ,  
 $V_{g1}=V_{g2}=V_{g3}=-0.3$  to  $-0.5\text{V}$ ,  $Z_o = 50\ \Omega$**

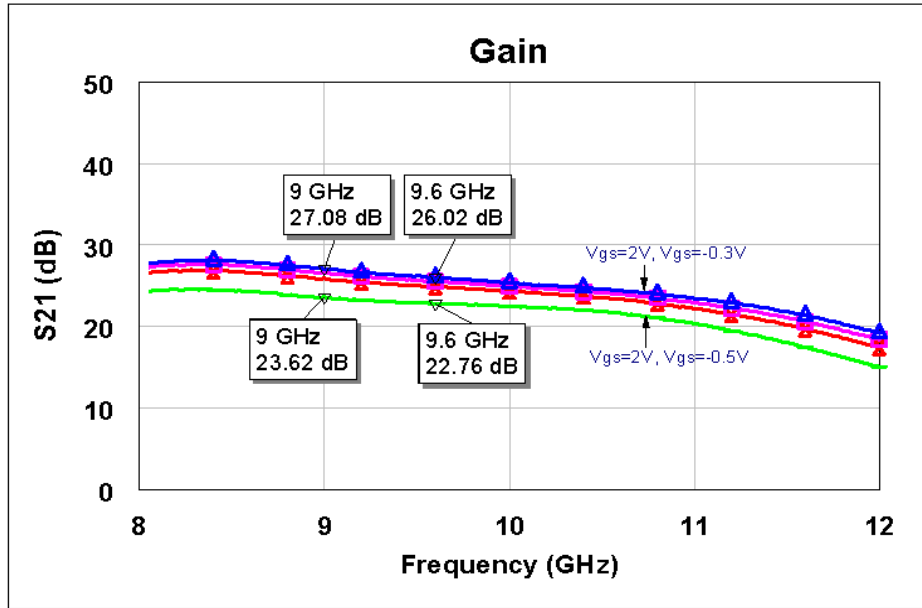
Parameter	Typ	Units
Frequency Range	9.0-9.6	GHz
Gain	26.5	dB
Gain Flatness	$\pm 0.5$	dB
Noise Figure	1.3	dB
Input Return Loss	12	dB
Output Return Loss	10	dB
Output Power (P1dB)	+10	dBm
Saturated Output Power (Psat)	+13	dBm
Output Third Order Intercept (IP3)	20	dBm
Supply Current (Id) ( $V_{d1} = V_{d2} = V_{d3} = 5\text{V}$ ) ( $V_{g1}=V_{g2}=V_{g3} = -0.3$ to $-0.5\text{V}$ )	75	mA

**Note:**

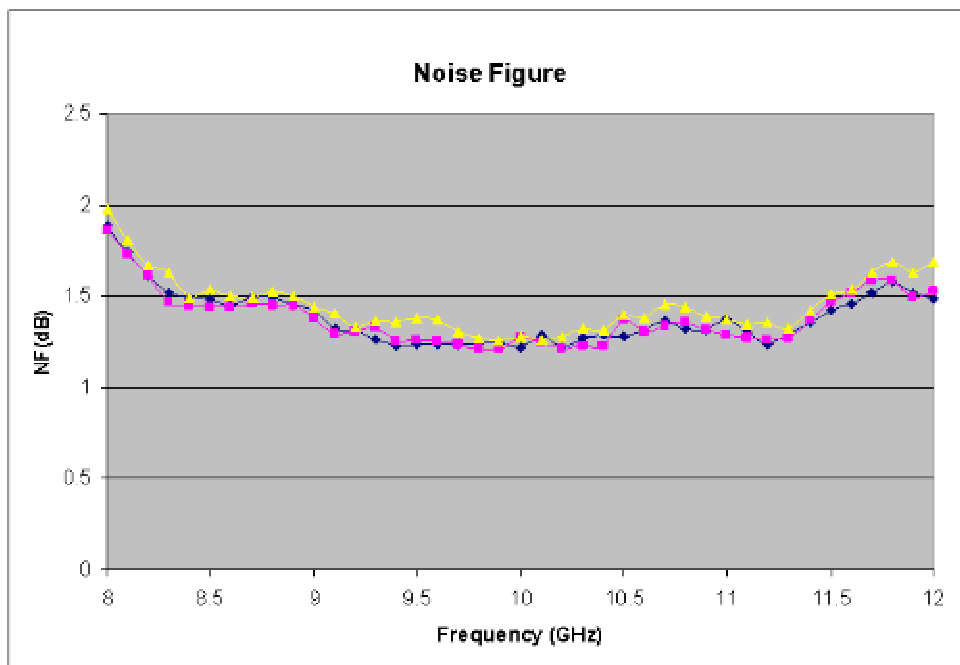
1. Electrical performance from test fixture measurements

**Test fixture data**

$V_{d1}=V_{d2}=V_{d3}=5V$ ,  $V_{g1}=V_{g2}=V_{g3}=-0.3V$  to  $-0.5V$ . Total Current = 75ma,  $T_A = 25^\circ C$

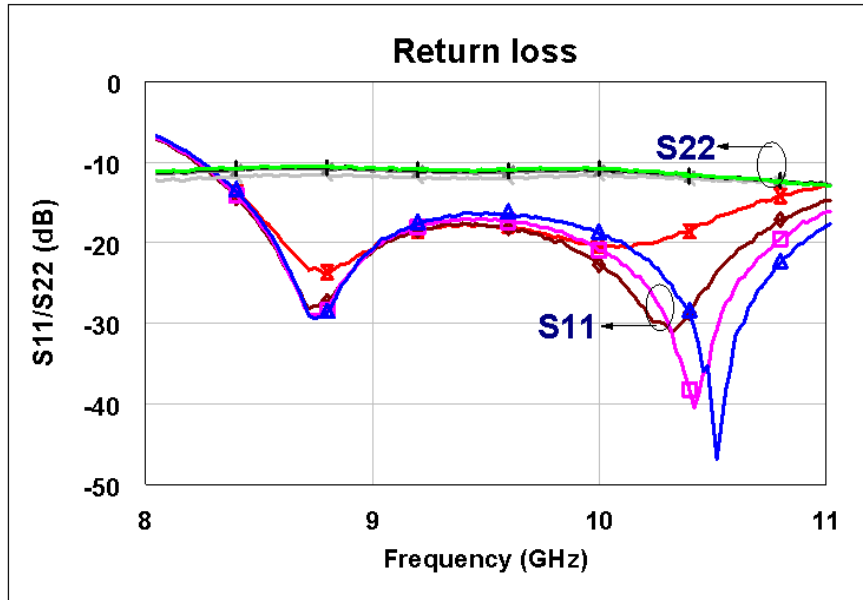

**Test fixture data**

$V_{d1}=V_{d2} = V_{d3} = 5V$ ,  $V_{g1}=V_{g2}=V_{g3}=-0.3$  to  $-0.5V$ . Total Current = 75ma,  $T_A = 25^\circ C$



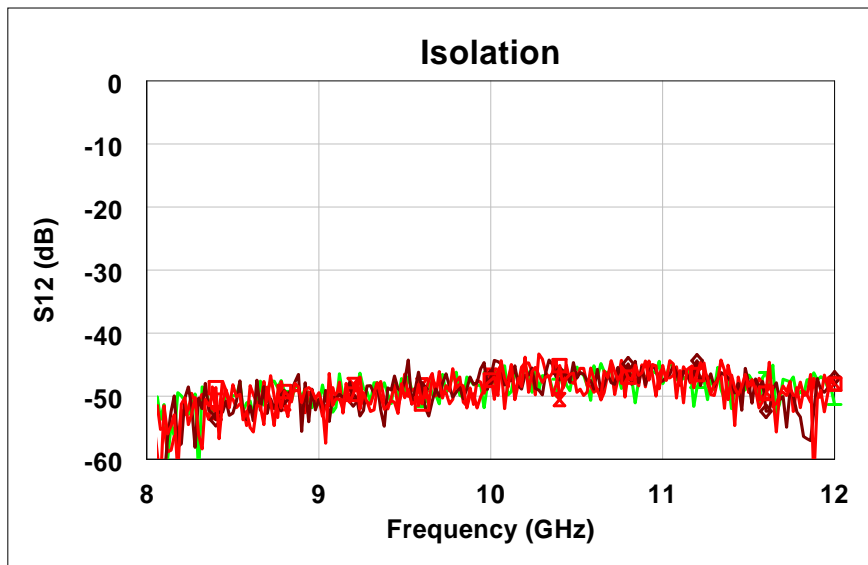
**Test fixture data**

$Vd1=Vd2=Vd3=5V$ ,  $Vg1=Vg2=Vg3=-0.3$  to  $-0.5$  V. Total Current =75ma,  $T_A=25^\circ C$



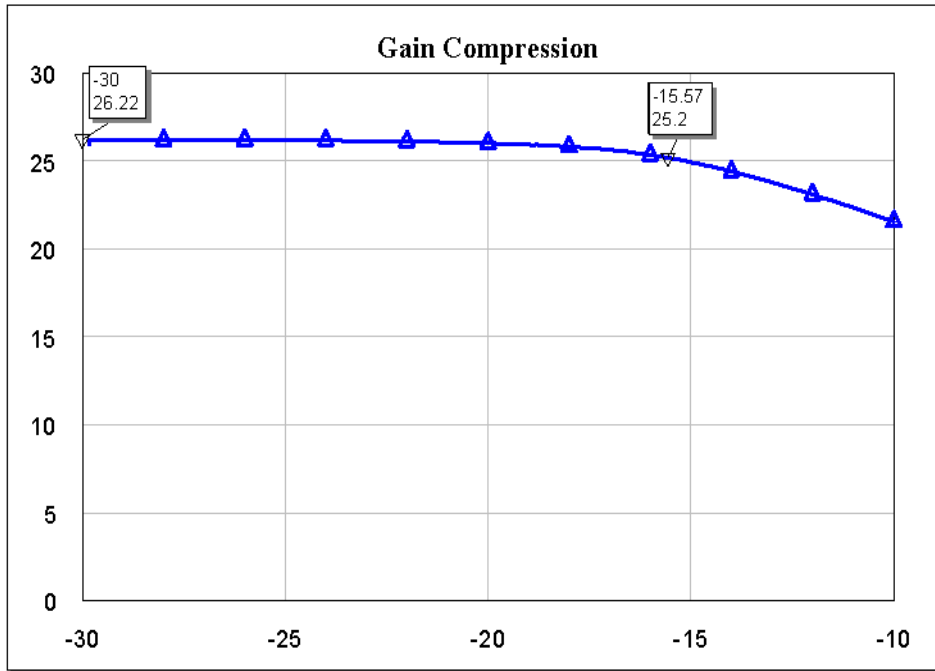
**Test fixture data**

$Vd1=Vd2=Vd3=5V$ ,  $Vg1=Vg2=Vg3=-0.3$  to  $-0.5$  V. Total Current =75ma,  $T_A=25^\circ C$



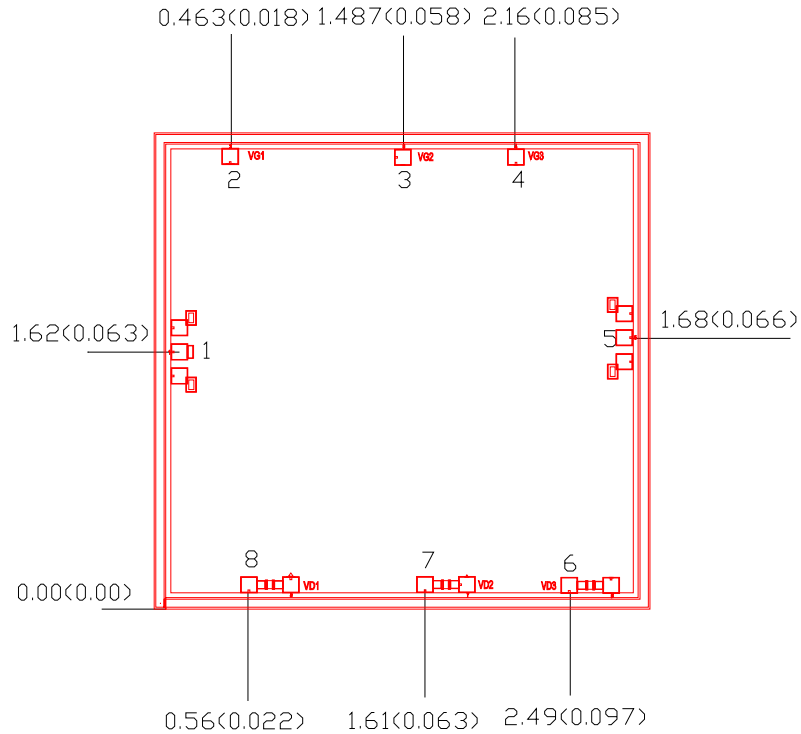
**Test fixture data**

$V_{d1}=V_{d2} = V_{d3} = 5V$ ,  $V_{g1}=V_{g2}=V_{g3}=-0.3 V$ . Total Current =75ma,  $T_A =25^\circ C$



**Pout at 1 dB compression = 10 dBm@9 GHz**

## Mechanical Characteristics



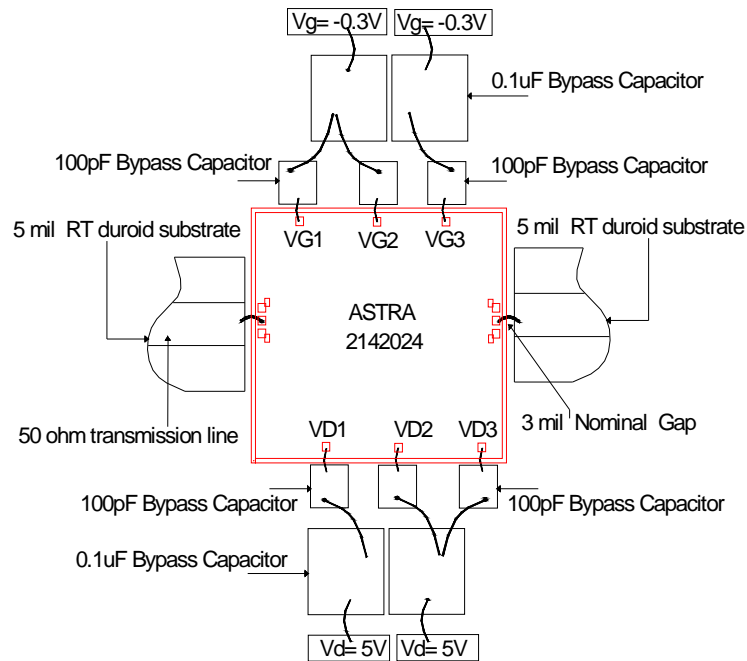
**Units: Millimeters [Inches]**

**All RF and DC bond pads are 100µm x 100µm**

**Note:**

- Pad 1 : RF in
- Pad 2 : VG1 (-0.3V to -0.5V)
- Pad 3 : VG2 (-0.3V to -0.5V)
- Pad 4 : VG3 (-0.3V to -0.5V)
- Pad 5 : RFout
- Pad 6 : VD3 (5V)
- Pad 7 : VD2 (5V)
- Pad 8 : VD3 (5V)

## Recommended Assembly Diagram



### Note:

1. Two 1 mil (0.0254mm) bond wires of minimum length should be used for RF input and output.
2. Two 1 mil (0.0254mm) bond wires of minimum length should be used from chip bond pad to 100pF capacitor.
3. Input and output 50 ohm lines are on 5 mil substrate.
4. 0.1  $\mu$ F capacitors may be additionally used as a second level of bypass for reliable operation.

**Die attach:** Use AuSn (80/20) 1-2 mil. Preform solder.

**Wire bonding:** For DC pad connections use either ball or wedge bonds. For best RF performance, use of 150 - 200 $\mu$ m length of wedge bonds is advised. Ball bonds are also acceptable.



**GaAs MMIC devices are susceptible to Electrostatic discharge. Proper precautions should be observed during handling, assembly & testing**

All information and Specifications are subject to change without prior notice